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Vishay/Siliconix SUP60N10-18P-E3

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SUP60N10-18P

Vishay Siliconix

COMPLIANT

N-Channel 100-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	R _{DS(on)} (Ω) I _D (A)		Q _g (Typ.)	
100	0.0183 at V_{GS} = 10 V	60	48	
	0.023 at V_{GS} = 8.0 V	53	40	

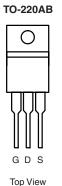
Ordering Information: SUP60N10-18P-E3 (Lead (Pb)-free)

FEATURES

- TrenchFET[®] Power MOSFET
- 100 % R_g and UIS Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Industrial
- Power Supply



N-Channel MOSFET

ABSOLUTE MAXIMUM RATING	S T _C = 25 °C, unless other	erwise noted			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	100	V	
Gate-Source Voltage		V _{GS}	± 20		
Continuous Drain Current (T _J = 175 °C)	T _C = 25 °C		60		
	T _C = 70 °C	I _D	50		
Pulsed Drain Current		I _{DM}	100	A	
Avalanche Current		I _{AS}	45		
Single Avalanche Energy ^a	L = 0.1 mH	E _{AS}	101	mJ	
Maximum Power Dissipation ^a	T _C = 25 °C	P	150 ^b	w	
	T _A = 25 °C ^c	– P _D –	3.75		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS				
Parameter	Symbol	Limit	Unit	
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	40	°C/W	
Junction-to-Case (Drain)	R _{thJC}	1.0		

Notes:

a. Duty cycle ≤ 1 %.

b. See SOA curve for voltage derating.

c. When Mounted on 1" square PCB (FR-4 material).



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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static	<u> </u>				<u> </u>	
Drain-Source Breakdown Voltage	V _{DS}	$V_{DS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	100			v
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2.5		4.5	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 250	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 100 V, V _{GS} = 0 V			1	μΑ
		$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$			50	
		$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 175 ^{\circ}\text{C}$			250	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	50			А
Drain-Source On-State Resistance ^a		V _{GS} = 10 V, I _D = 15 A		0.015	0.0183	Ω
	R _{DS(on)}	V_{GS} = 10 V, I _D = 15 A, T _J = 125 °C		0.027	0.033	
		V _{GS} = 8.0 V, I _D = 10 A		0.018	0.023	
Forward Transconductancea	9 _{fs}	V _{DS} = 15 V, I _D = 15 A		33		S
Dynamic ^b						
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 50 V, f = 1 MHz		2600		pF
Output Capacitance	C _{oss}			230		
Reverse Transfer Capacitance	C _{rss}			80		
Total Gate Charge ^c	Qg			48	75	nC
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 50$ V, $V_{GS} = 10$ V, $I_{D} = 50$ A		16		
Gate-Drain Charge ^c	Q _{gd}			13		
Gate Resistance	R _g	f = 1 MHz	0.25	1.1	2.4	Ω
Turn-On Delay Time ^c	t _{d(on)}			12	20	
Rise Time ^c	t _r	V_{DD} = 50 V, R _L = 1.0 Ω I _D \cong 50 A, V _{GEN} = 10 V, R _g = 1 Ω		10	20	ns
Turn-Off Delay Time ^c	t _{d(off)}			18	35	
Fall Time ^c	t _f			8	15	
Drain-Source Body Diode Character	istics T _C = 25	°Cp				
Continuous Current	ا _S				60	A
Pulsed Current	I _{SM}			1	100	
Forward Voltage ^a	V _{SD}	$I_{F} = 15 \text{ A}, V_{GS} = 0 \text{ V}$		0.85	1.5	V
Reverse Recovery Time	t _{rr}			80	120	ns
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 50 A, dl/dt = 100 A/μs		4		Α
Reverse Recovery Charge	Q _{rr}			160	240	nC

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

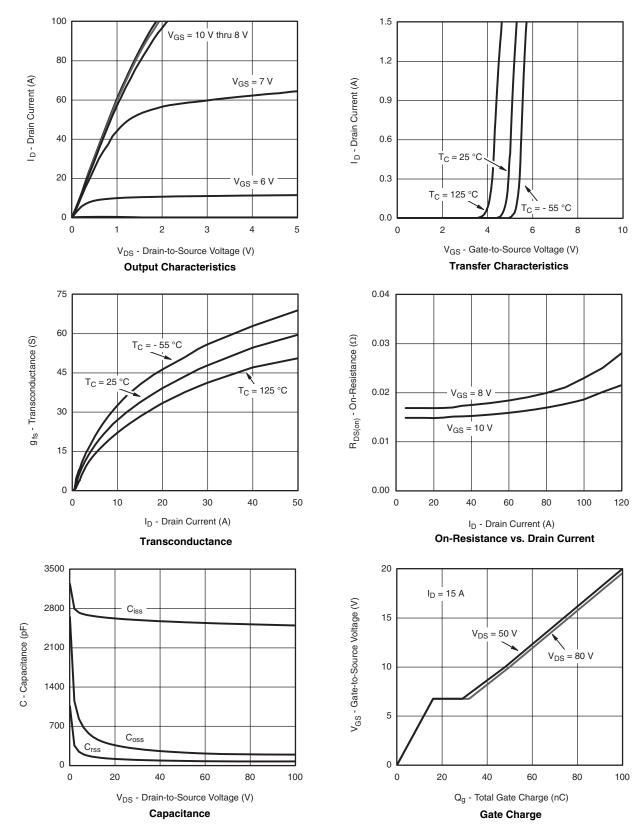
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

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T_J = 25 °C≣

0.8

1.0

I_D = 5 mA

125 150

175

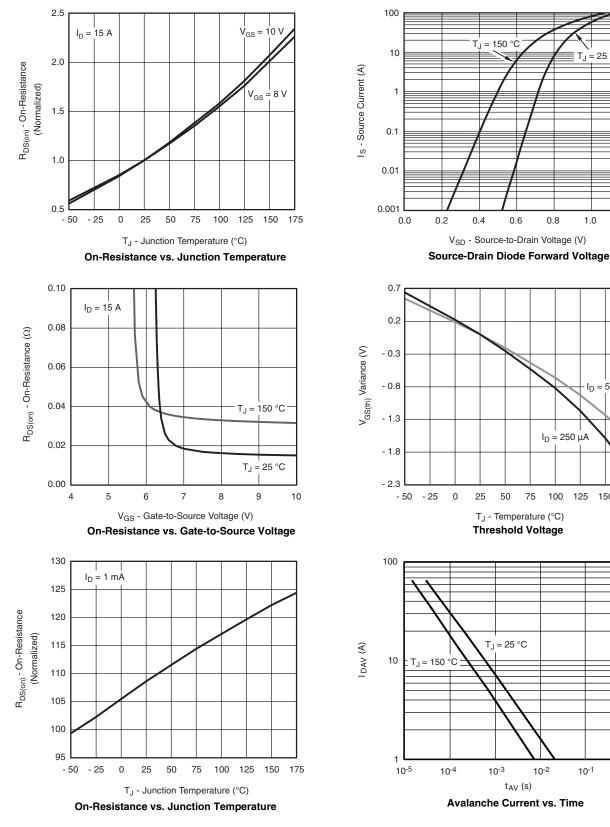
 $I_D = 250 \ \mu A$

1.2

0.6

50 75 100

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



10⁻¹

1

10-2

 t_{AV} (s)

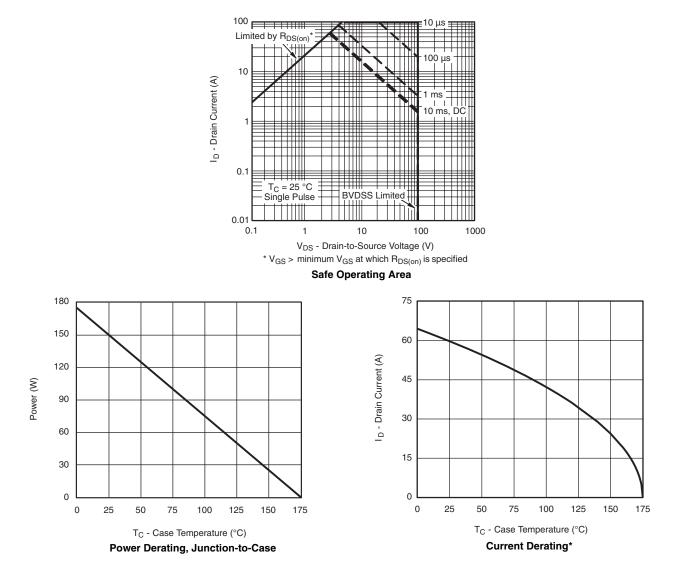




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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



* The power dissipation P_D is based on $T_{J(max.)} = 175 \,^{\circ}C$, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

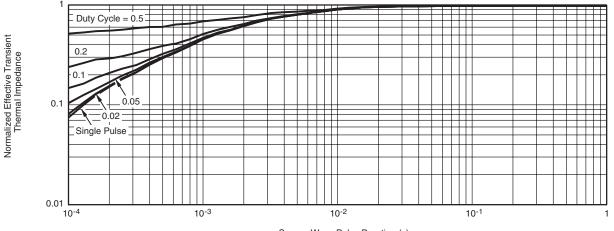


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Square Wave Pulse Duration (s)

Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?65003.





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